

TEF0008 TRM

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Overview

The Trenc Electronic TEF0008 is a FPGA to Mezzanine Card (FMC) based on VITA 57.1 FMC HPC Standard, with four SFP+ 10Gb ports for fiber optical SFP modules. It is intended for use on a FMC HPC carrier and can not be used stand-alone.

Key Features

- Four SFP+ 10Gb ports
- HPC FMC connector

- Low jitter programmable clock generator
- Intel(Altera) Max10 FPGA 10M08SAU169C8G
- Status LED (green)

Block Diagram

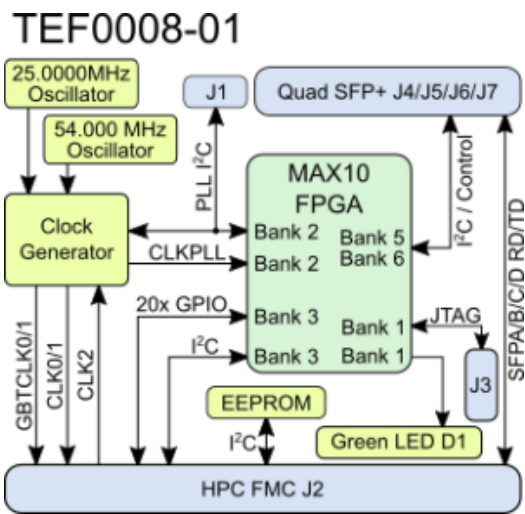


Figure 1: TEF0008 block diagram.

Main Components

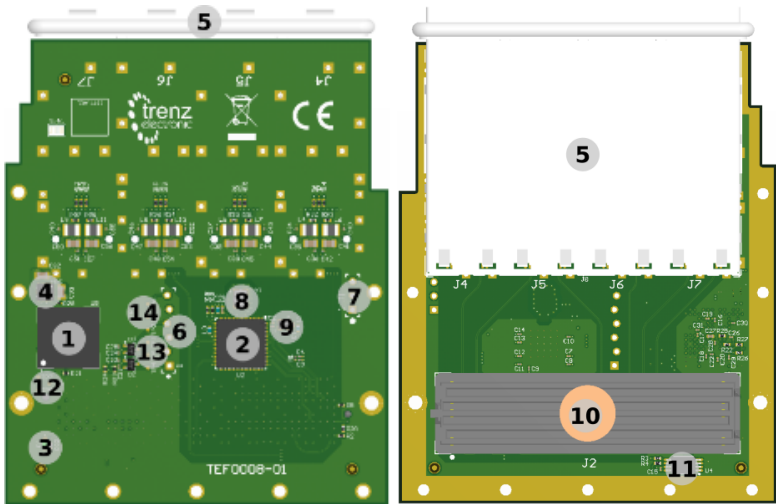


Figure 2: TEF0008 FMC overview.

Table 1: TEF0008 main components.

- 1. MAX10 FPGA, U5
- 2. Programmable low jitter clock generator Si5354A, U2
- 3. Status LED (green), D1
- 4. 3.3V to 1.8V DCDC converter, U6
- 5. Quad SFP+ cage and connectors, J4-J7
- 6. 1x6 pin header for JTAG programming of FPGA (3.3V), J3
- 7. 1x3 pin header for I²C (1.8V), J1
- 8. XTAL 54.0000 MHz (CX3225SB), Y1
- 9. Oszillator 25.000000 MHz (SiT8008B), U1
- 10. HPC FMC connector, J2
- 11. 128KBit EEPROM, U4
- 12. Testpoints Max10, TP7-TP9
- 13. Testpoints JTAG, TP1-TP4
- 14. Testpoints Power, TP5, TP6, TP10

Initial Delivery State

Storage device name	Content	Notes
Max10 FPGA 10M08SAU169C8G	Programmed	U5. Level shifter and controlller functions.
Clock generator Si5345A-B-GM	Programmed	U2. OUT0 25MHz, OUT2 125MHz, OUT7 156.25 MHz, OUT8 156.25MHz, OUT9 125MHz.
EEPROM 24LC128-I/ST	empty	U4, IPMI and VITA57.1 compatible.

Table 1: Initial delivery state of programmable devices on the module.

Boot Process

The MAX10 FPGA boots form its internal configuration flash memory, which is programmable via JTAG (J3).

Signals, Interfaces and Pins

Board to Board (B2B) I/Os

I/O signals connected to the FPGA I/O bank and B2B connector:

Bank	Type	B2B Connector	I/O Signal Count	Bank Voltage	Notes
3	GPI/Os	J2	20 I/Os	VADJ	Supplied by the carrier board.

Table 2: General overview of I/O signals connected to the B2B connectors.

MGT Lanes

MGT (Multi Gigabit Transceiver) lane consists of one transmit and one receive (TD/RD) differential pairs, two signals each or four signals total per one MGT lane. Following table lists lane number, MGT bank number, transceiver type, signal schematic name, and HPC FMC Pin:

Lane	SFP+	Signal Name	HPC FMC Pin
------	------	-------------	-------------

0	J4	• SFPA_RD_P • SFPA_RD_N • SFPA_TD_P • SFPA_TD_N	• J2-C6 • J2-C7 • J2-C2 • J2-C3
1	J5	• SFPB_RD_P • SFPB_RD_N • SFPB_TD_P • SFPB_TD_N	• J2-A2 • J2-A3 • J2-A22 • J2-A23
2	J6	• SFPC_RD_P • SFPC_RD_N • SFPC_TD_P • SFPC_TD_N	• J2-A6 • J2-A7 • J2-A26 • J2-A27
3	J7	• SFPD_RD_P • SFPD_RD_N • SFPD_TD_P • SFPD_TD_N	• J2-A10 • J2-A11 • J2-A30 • J2-A31

Table 3: MGT lanes.

Below are listed MGT banks reference clock sources.

Clock signal	Source	HPC FMC Pin	Notes
GBTCLK0_P	U2-51	J2-D4, GBTCLK0_M2C_P	On-board Si5345A.
GBTCLK0_N	U2-50	J2-D5, GBTCLK0_M2C_N	On-board Si5345A.
GBTCLK1_P	U2-31	J2-B20, GBTCLK1_M2C_P	On-board Si5345A.
GBTCLK1_N	U2-30	J2-B21, GBTCLK1_M2C_N	On-board Si5345A.

Table 4: MGT reference clock sources.

SFP+ Control Interface

Following table contains a brief description of the control and status signals of the SFP+ connectors:

Signal Schematic Name	FPGA Direction	Description	Logic
SFPx_TX_DISABLE	Output	SFP Enabled / Disabled	Low active
SFPx_LOS	Input	Loss of receiver signal	High active
SFPx_RS0	Output	Full RX bandwidth	Low active
SFPx_RS1	Output	Reduced RX bandwidth	Low active
SFPx_M-DEF0	Input	Module present / not present	Low active
SFPx_TX_FAULT	Input	Fault / Normal Operation	High active
SFPx_SDA	BiDir	2-wire Serial Interface Data	-
SFPx_SCL	Output (BiDir)	2-wire Serial Interface Clock	-

Table 5: Overview of SFP control Signals.



Up to 100kHz the modules operate without clock stretching. Therefore SCL can be implemented as driven by Master only.

JTAG Interface

JTAG access to the MAX10 FPGA is provided through HPC FMC Connector and an additional pin header connector as well as testpoints.

JTAG Signal	HPC FMC Pin	Pin Header	Testpoints
TCK	J2-D29	J3-4	TP2
TDI	J2-D33	J3-2	TP1
TDO	J2-D30	J3-3	TP3
TMS	J2-D31	J3-1	TP4

Table 6: JTAG interface signals.

I²C Interface

Despite the EEPROM U4 all other on-board I²C devices are connected to the MAX10 FPGA for level shift and I²C MUX. Addresses for devices are listed in the table below. The EEPROM is accessed via the FMC connector.

I ² C Device	I2C Address	Notes
J4, SFP+	1100001 / 1100000	Conventional SFP Memory / Enhanced Feature Set Memory, Device select via MAX10 FPGA implementation.
J5, SFP+	1100001 / 1100000	Conventional SFP Memory / Enhanced Feature Set Memory, Device select via MAX10 FPGA implementation.
J6, SFP+	1100001 / 1100000	Conventional SFP Memory / Enhanced Feature Set Memory, Device select via MAX10 FPGA implementation.
J7, SFP+	1100001 / 1100000	Conventional SFP Memory / Enhanced Feature Set Memory, Device select via MAX10 FPGA implementation.
U2, Si5345A	1101001	Level shifted via MAX10 FPGA, Device select via MAX10 FPGA implementation.
U4, EEPROM	10100xx	Last digits determined by carrier board via HPC FMC (C34 GA0, C35 GA1).

Table 7: I²C slave device addresses.

HPC FMC Connector

The following table lists all on the FMC connector assigned net names.

	A	B	C	D	E	F	G	H	J	K
1	GND	NetJ2_B1	GND	PG_C2M	GND	PG_M2C	GND		GND	
2	SFPB_RD_P	GND	SFPA_TD_P	GND		GND	CLK1_P	GND		GND
3	SFPB_RD_N	GND	SFPA_TD_N	GND		GND	CLK1_N	GND		GND
4	GND		GND	GBTCLK0_P	GND		GND	CLK0_P	GND	CLK2_P
5	GND		GND	GBTCLK0_N	GND		GND	CLK0_N	GND	CLK2_N
6	SFPC_RD_P	GND	SFPA_RD_P	GND		GND	LA00_P	GND		GND

7	SFPC_RD_N	GND	SFPA_RD_N	GND			LA00_N	LA02_P		
8	GND		GND	LA01_P	GND		GND	LA02_N	GND	
9	GND		GND	LA01_N		GND	LA03_P	GND		GND
10	SFPD_RD_P	GND	LA06_P	GND			LA03_N	LA04_P		
11	SFPD_RD_N	GND	LA06_N	LA05_P	GND		GND	LA04_N	GND	
12	GND		GND	LA05_N		GND	LA08_P	GND		GND
13	GND		GND	GND			LA08_N	LA07_P		
14		GND		LA09_P	GND		GND	LA07_N	GND	
15		GND		LA09_N		GND		GND		GND
16	GND		GND	GND						
17	GND		GND		GND		GND		GND	
18		GND				GND		GND		GND
19		GND		GND						
20	GND	GBTCLK1_P	GND		GND		GND		GND	
21	GND	GBTCLK1_N	GND			GND		GND		GND
22	SFPB_TD_P	GND		GND						
23	SFPB_TD_N	GND			GND		GND		GND	
24	GND		GND			GND		GND		GND
25	GND		GND	GND						
26	SFPC_TD_P	GND			GND		GND		GND	
27	SFPC_TD_N	GND				GND		GND		GND
28	GND		GND	GND						
29	GND		GND	TCK	GND		GND		GND	
30	SFPD_TD_P	GND	FMC_SCL	TDI		GND		GND		GND
31	SFPD_TD_N	GND	FMC_SDA	TDO						
32	GND		GND	3P3VAUX	GND		GND		GND	
33	GND		GND	TMS		GND		GND		GND
34		GND	GA0							
35		GND	12V	GA1	GND		GND		GND	
36	GND		GND	3P3V		GND		GND		GND
37	GND		12V	GND						
38		GND	GND	3P3V	GND		GND		GND	
39		GND	3P3V	GND	VADJ	GND	VADJ	GND		GND
40	GND		GND	3P3V	GND	VADJ	GND	VADJ	GND	

Table 8: HPC FMC Connector pin assignment.

On-board Peripherals

MAX10 FPGA

The MAX10 FPGA (10M08SAU169C8G) is used as SFP control, level shifter and I²C MUX. For a detailed description see [TEF0008 MAX10](#).

Programmable Clock Generator

There is a Silicon Labs I²C programmable clock generator on-board (Si5345A, U2) to generate reference clocks for the module. Programming can be done using I²C via PIN header J1. The I²C bus is also routed to the MAX10 FPGA.

Si5345A Pin	Signal Name / Description	Connected To	Direction	Note	Default
IN0	Reference input clock.	U1	Input	25.000000 MHz oscillator, Si8208AI	
IN1	-	Not connected.	Input	Not used.	
IN2	-	Not connected.	Input	Not used.	
IN3	CLK2	J2-K4/K5	Input	HPC FMC configured as C2M clock.	
A1	-	GND	Input	I ² C slave device address LSB.	
XAXB	-	Y1	Input	54.0000 MHz XTAL CX3225SB	
OUT0	CLKPLL2F	U5-H6/G5	Output	FPGA bank 2.	25MHz
OUT1	-	Not connected.	Output	Not used.	---
OUT2	GBTCLK1	J2-B20/B21	Output	M2C via HPC FMC.	125MHz
OUT3	-	Not connected.	Output	Not used.	---
OUT4	-	Not connected.	Output	Not used.	---
OUT5	-	Not connected.	Output	Not used.	---
OUT6	-	Not connected.	Output	Not used.	---
OUT7	GBTCLK0	J2-D4/D5	Output	M2C via HPC FMC.	156.25MHz
OUT8	CLK0	J2-H4/H5	Output	M2C via HPC FMC.	156.25MHz
OUT9	CLK1	J2-G2/G3	Output	M2C via HPC FMC.	125MHz

Table 9: Programmable clock generator inputs and outputs.

Oscillators

The module has following reference clock signals provided by on-board oscillators and external source from carrier board:

Clock Source	Schematic Name	Frequency	Clock Destination
SiTime SiT8008AI oscillator, U1	-	25.000000 MHz	U2-63/64
Carrier board via HPC FMC J2-K4/K5	CLK2	Defined by carrier.	U2-61/62

Table 10: Reference clock signals.

EEPROM

A Microchip 24LC128-I/LC serial EEPROM (U4) is provided for IPMI data. It is accessible via the LPC FMC connector (SCL C30, SDA C31).

On-board LED

LED	Color	Connected to	Description and Notes
D1	Green	U5-C2 (bank 1A)	Depending on FPGA design. With the shipped FPGA design it is on, if at least one SFP is connected.

Table 11: On-board LED.

Power and Power-On Sequence

Power Consumption

The maximum power consumption of a module depends on the design running on the FPGA.

3P3V	TBD*
VADJ (at 1.8V)	TBD*
3P3VAUX	TBD*

Table 12: Typical power consumption.

* TBD - To Be Determined with reference design setup.

Power Distribution Dependencies

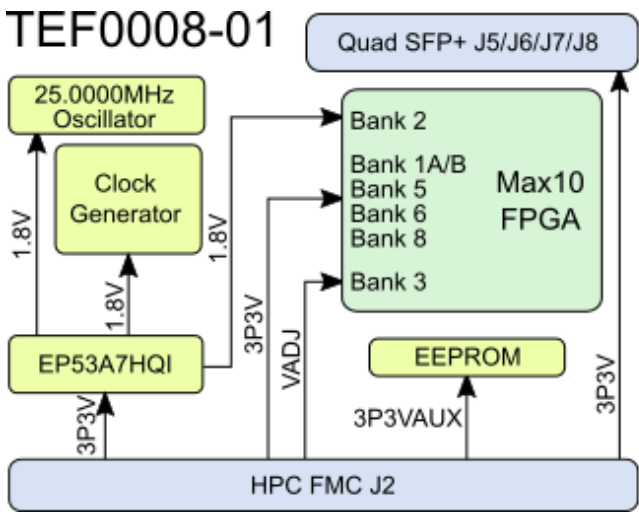


Figure 3: Module power distribution diagram.

Power Rails

Power Rail Name	HPC FMC Connector (J2)	Direction	Notes
3P3V	D36, D38, D40, C39	Input	Supply voltage from carrier board.
1.8V	-	Output	Module on-board 1.8V voltage supply (Max 1A).
3P3VAUX	D32	Input	Supply voltage from carrier board.
VADJ	H40, G39, F40, E39	Input	Supply voltage from carrier board.
12V	C35, C37	Input	Not used supply voltage from carrier board.

Table 13: Module power rails.

Bank Voltages

Bank	Schematic Name	Voltage	Voltage Range
1A	3P3V	3.3V	-
1B	3P3V	3.3V	-
2	1.8V	1.8V	-
3	VADJ	Carrier supplied	1.2V - 3.3V
5	3P3V	3.3V	-
6	3P3V	3.3V	-
8	3P3V	3.3V	-

Table 14: Module PL I/O bank voltages.

Variants Currently In Production

Module Variant	FPGA	Operating Temperature	Temperature Range
TE0008-02	10M08SAU169C8G	0°C to +85°C	Extended

Table 15: Module variants.

Technical Specifications

Absolute Maximum Ratings

Parameter	Min	Max	Units	Reference Document
Storage temperature	-40	85	°C	-

Table 16: Module absolute maximum ratings.

Operating Temperature Ranges

Extended grade: 0°C to +85°C.

Physical Dimensions

- Module size: 69 mm × 84 mm, SFP+ conector excluded (+ 5.5 mm). See Vita 57.1 standard.
- PCB thickness: 1.6 mm.
- Highest part on PCB top is 9.5 mm (SFP+ cage, excluded front plate), bottom 1.4 mm (MAX10 FPGA). Please download the step model for exact numbers.

All dimensions are given in millimeters.

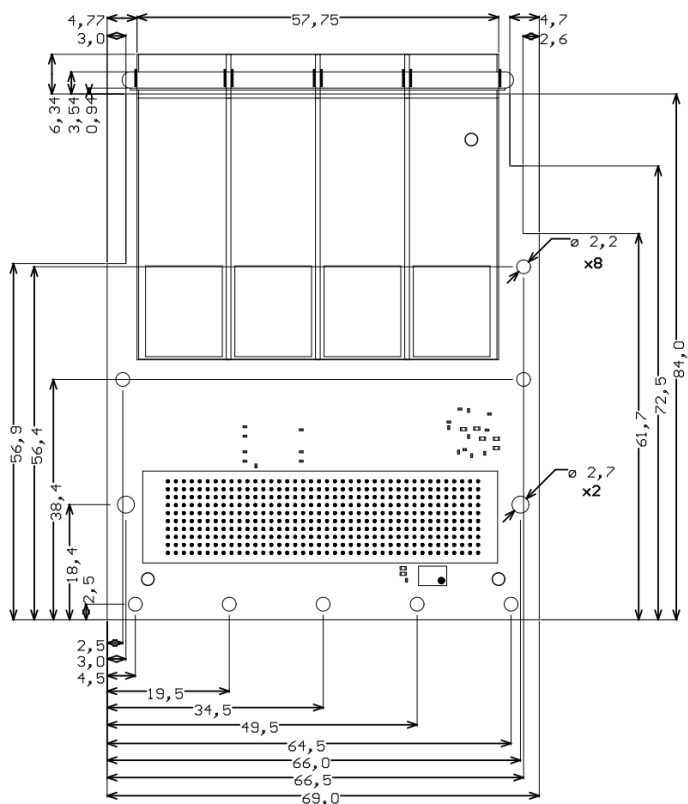


Figure 4: Module physical dimensions drawing



Mounting holes near the front pannel are not implemented due to physical restrictions caused by the SFP cage. The dimensions exceed in some area the by Vita 57.1 standard defined dimensions. In the middle region of the card the cage is higher than the specified max high for this area. Check carefully if the carrier card uses this space for other components conflicting mechanical. The bottom side is at the high limit.

Revision History

Hardware Revision History

Date	Revision	Notes	PCN	Documentation Link
2018-06-06	02	First production release		
-	01	Prototypes		

Table 17: Module hardware revision history.

Hardware revision number can be found on the PCB board together with the module model number separated by the dash.

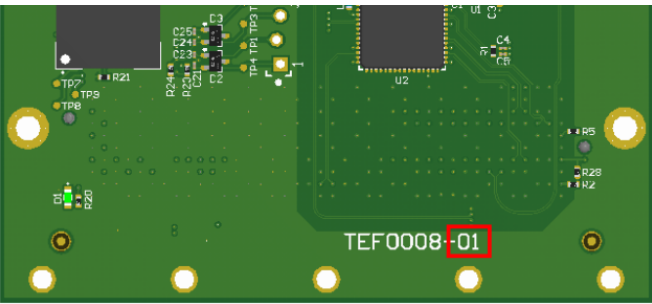


Figure 5: Module hardware revision number.

Document Change History

Date	Revision	Contributors	Description
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Error rendering macro 'page-info' Ambiguous method overloading for method jdk.proxy279.\$Proxy4022#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]	Error rendering macro 'page-info' Ambiguous method overloading for method jdk.proxy279.\$Proxy4022#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]	Error rendering macro 'page-info' Ambiguous method overloading for method jdk.proxy279.\$Proxy4022#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]	• add default CLK values also to SI section • changes on document change history style
2018-08-24	v.38	Martin Rohrmüller	• Updated Table 15 and 17 to Rev02. • Added FMC connector pin assignment (Table 8).
2018-06-15	v.32	Martin Rohrmüller	• Initial document.

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Table 18: Document change history.

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Ambiguous method overloading for method `jdk.proxy279.$Proxy4022#hasContentLevelPermission`. Cannot resolve which method to invoke for `[null, class java.lang.String, class com.atlassian.confluence.pages.Page]` due to overlapping prototypes between: `[interface com.atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]` `[interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]`

02 Sept 2017